# EVERLIGHT ELECTRONICS CO.,LTD.

# **Technical Data Sheet**

# **Chip LED with Right Angle Lens**

### 22-21/GHC-YR1S2/2C

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain with RoHS compliant version.

#### **Descriptions**

- The 22-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

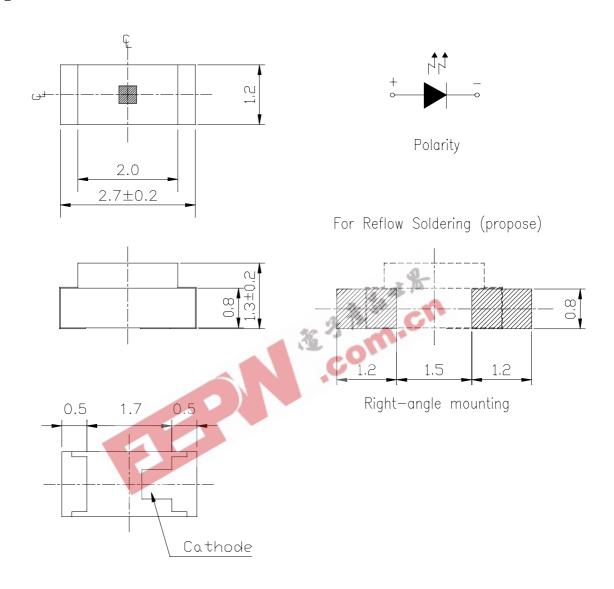
D. AND	C	I a con Cala	
Part No.	Material	Emitted Color	Lens Color
22-21/GHC-YR1S1/2C	InGaN	Brilliant Green	Water Clear



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10

Device No.: SZDSE-221-G01 Prepared date: 24-Aug-2005 Prepared by: Wang Zhiyong

# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

Everlight Electronics Co., Ltd.

http://www.everlight.com

P

Rev.1

Page: 2 of 10

Device No.: SZDSE-221-B02

Prepared date: 24-Aug-2005

Prepared by: Wang Zhiyong



# **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_R$	5		
Forward Current	$I_{\mathrm{F}}$	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	150	V	
Power Dissipation	Pd	110	mW	
Peak Forward Current (Duty 1/10 @1KHz)	$I_{\mathrm{FP}}$	100	mA	
Soldering Temperature	Tsol	Reflow Soldering:260 °C for 10 sec  Hand Soldering:350°C for 3 sec		

# Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{V}$	112		285	mcd	
Peak Wavelength	λp		518		nm	
Dominant Wavelength	λd	520		535	nm	
Spectrum Radiation Bandwidth	Δλ		35		nm	$I_F=20\text{mA}$
Viewing Angle	2 \theta 1/2		120		deg	
Forward Voltage	$V_{\mathrm{F}}$	2.7	3.3	3.7	V	
Reverse Current	$I_R$			50	μΑ	V <sub>R</sub> =5V

#### **Notes:**

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10



# ERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

# 22-21/GHC-YR1S1/2C

# **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition	
R1	112	140			
R2	140	180	1	I <sub>F</sub> =20mA	
S1	180	225	mcd		
S2	225	285			

### Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
	X	520	525		
Y	Y	525	530	nm 🔭	I <sub>F</sub> =20mA
	Z	530	535	2 1 C	0

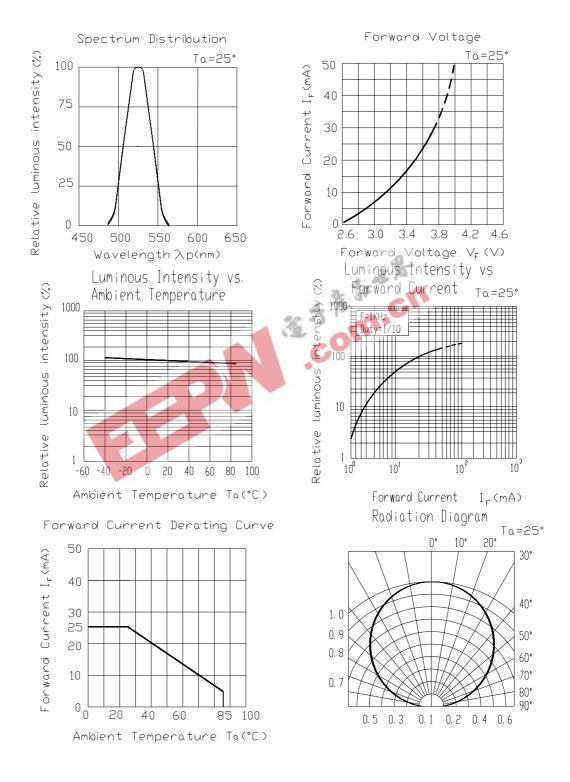
#### **Notes:**

1. Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10

# **Typical Electro-Optical Characteristics Curves**



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 10

Device No.: SZDSE-221-B02 Prepared date: 24-Aug-2005 Prepared by: Wang Zhiyong

## Label explanation

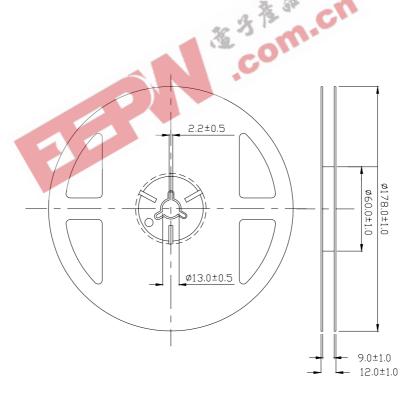
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



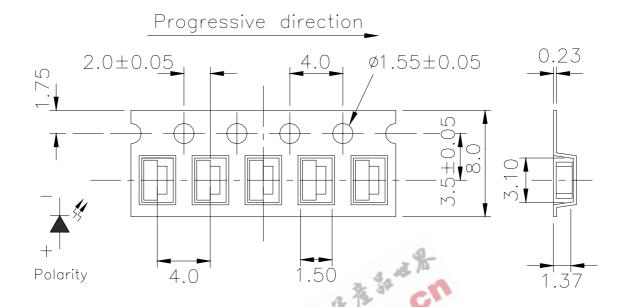
### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

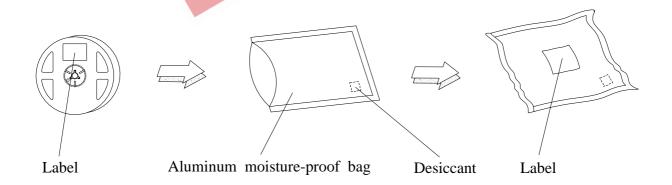
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 6 of 10

# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

# **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 7 of 10



# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 10 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85% RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10

Device No.: SZDSE-221-B02 Prepared date: 24-Aug-2005 Prepared by: Wang Zhiyong

#### **Precautions For Use**

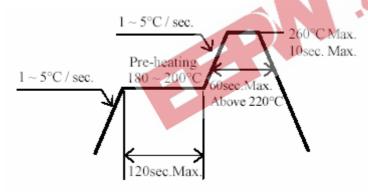
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
  - 2.3 The LEDs should be used within a year.
  - 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and  $60^{\circ}$ RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the com.cn storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Page: 9 of 10 Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1

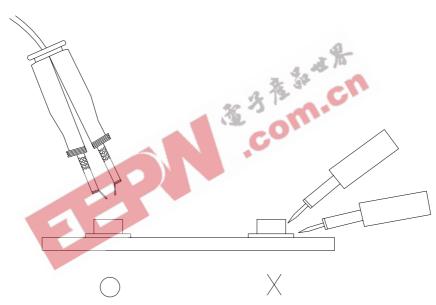


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10